## **DECLARATION AND POWER OF ATTORNEY**

As a below named inventor, I hereby declare that:

My residence, post office address, and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled "METHOD OF FORMING SEMICONDUCTOR STRUCTURES WITH REDUCED STEP HEIGHTS," the specification of which:

was filed on and was amended	as Applicatio	on Serial No applicable).		_
	have reviewed and unde	rstand the contents	s of the ab bove.	ove-identifie
I acknowledge the duty me to be material to patentab defined in 37 C.F.R. § 1.56.	y to disclose to the Patent a ility of the subject matter o	nd Trademark Office claimed in this applic	all informat cation, as "n	ion known nateriality"
I hereby claim foreign application(s) for patent or inve application listed below designated identified below any foreign ap- application, having a filing date	ating least one country othe oplication for patent or inve	w, or under § 365(a) r than the United Sta entor's certificate, or	of any PCT ates of Ameri of any PCT	internation
Prior Foreign Application No.	Country	Filing Date (mm/dd/yy)	Priority Claimed	Cert. cor Attache
NT / A				
I horoby claim the horo				
I hereby claim the bene listed below. Provisional Application No.	efit under 35 U.S.C. § 119(e)  Filing Date (mm/dd/yy)	of any United States	provisional a	application
I hereby claim the bene listed below.	efit under 35 U.S.C. § 119(e)  Filing Date (mm/dd/yy)	of any United States	provisional a	application
I hereby claim the bene listed below.  Provisional Application No.  N/A	Filing Date (mm/dd/yy)  Fit under 35 U.S.C. § 120 of international application libject matter of each of the clarnational application in the duty to disclose all infector claimed in this application between the filing date of the claraction of the claimed in this application.	f any United States a isted below designat aims of this applicati manner provided by ormation known to r ion, as "materiality"	pplication(s) ing the Unit ion is not dis the first par ne to be ma is defined in	listed belo ted States iclosed in t agraph of tterial to t
I hereby claim the bene listed below.  Provisional Application No.  N/A  I hereby claim the bene or under § 365(c) of any PCT America, and, insofar as the surprior United States or PCT inter U.S.C. § 112, I acknowledge to patentability of the subject main 1.56, which became available	Filing Date (mm/dd/yy)  Filing Date (mm/dd/yy)  Fit under 35 U.S.C. § 120 of international application libject matter of each of the clamational application in the duty to disclose all infetter claimed in this applicate between the filing date of the application.	f any United States a isted below designat aims of this applicati manner provided by ormation known to r ion, as "materiality"	pplication(s) ing the Unit ion is not dis the first par ne to be ma is defined in and the nat	listed belo ted States iclosed in t agraph of iterial to t 37 C.F.R. ional or Po

The Assignee hereby revokes any previous Powers of Attorney and appoints Andrew D. Fortney, Reg. No. 34,600 and Laura Lee M. Engurasoff, Reg. No. 42,886 of Cypress Semiconductor Corporation; and Kevin L. Daffer, Reg. No. 34,146; B. Noel Kivlin, Reg. No. 33,929; Eric B. Meyertons, Reg. No. 34,876; Gentry E. Crook, Reg. No. 44,633; and Mollie E. Hamel, Reg. No. 48,405 of the firm of Conley, Rose & Tayon, as attorney or agent for so long as they remain with such company or firm, with full power of substitution and revocation, to prosecute the application, to make alterations and amendments therein, to transact all business in the Patent and Trademark Office in connection therewith, and to receive the Letters Patent.

Please direct all communications to:

Kevin L. Daffer Conley, Rose & Tayon, P.C. P.O. Box 398 Austin, Texas 78767-0398 Phone: (512) 476-1400

I hereby declare that all statements made herein of my own knowledge are true and that all statements made herein on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under 18 U.S.C. § 1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

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